LNJ224C44RA

Hight Bright Surface Mounting Chip LED

3528 (PLCC2) Type

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	PD	80	mW	
Forward current	I _F	30	mA	
Pulse forward current *	I _{FP}	90	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-40 to +100	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Lighting Color

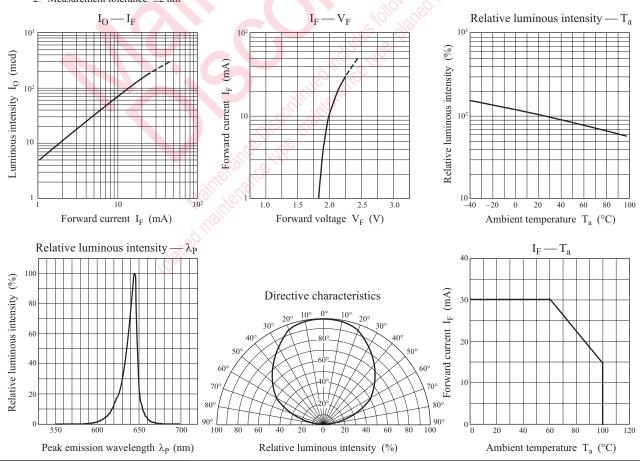
• Red

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	S Unit
Luminous intensity *1	Io	$I_F = 20 \text{ mA}$	75	150 5	250	mcd
Reverse current	I _R	$V_R = 4 V$		d'and in	5100	μΑ
Forward voltage	V _F	$I_F = 20 \text{ mA}$		2.1	2.5	V
Peak emission wavelength	λ_{P}	$I_F = 20 \text{ mA}$	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	645		nm
Dominant emission wavelength *2	λ_d	$I_F = 20 \text{ mA}$	624	630	636	nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$	dille	20		nm

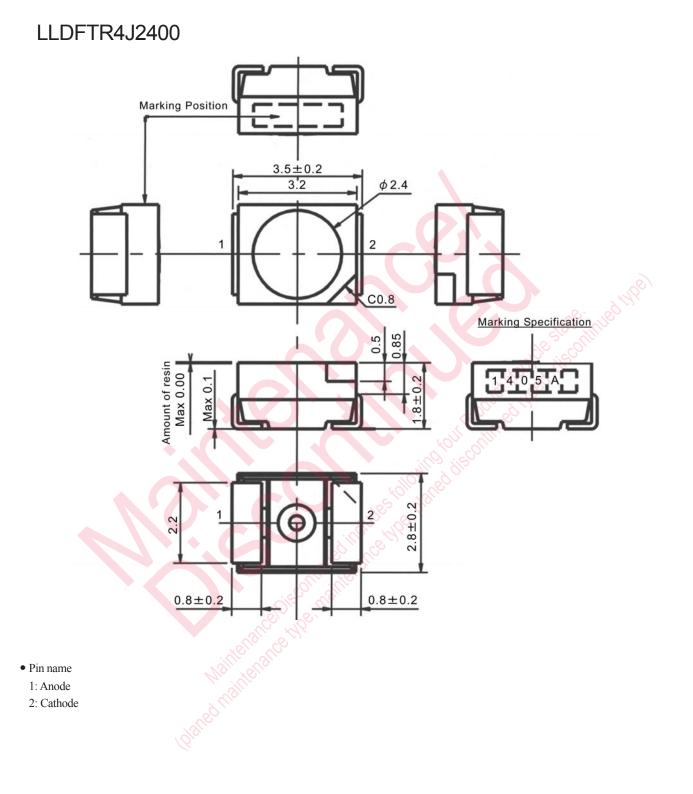
Note) *1: Measurement tolerance: ±15% *2: Measurement tolerance: ±2 nm



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Package (Unit: mm)



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